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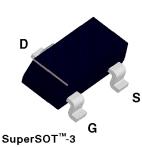
NDS331N N-Channel Logic Level Enhancement Mode Field Effect Transistor

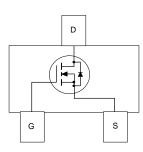
General Description

These N-Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications in notebook computers, portable phones, PCMCIA cards, and other battery powered circuits where fast switching, and low in-line power loss are needed in a very small outline surface mount package.

Features

- 1.3 A, 20 V. $R_{DS(ON)} = 0.21 \Omega @ V_{GS} = 2.7 V$ $R_{DS(ON)} = 0.16 \Omega @ V_{GS} = 4.5 V.$
- Industry standard outline SOT-23 surface mount package using poprietary SuperSOT[™]-3 design for superior thermal and electrical capabilities.
- High density cell design for extremely low R_{DS(ON)}.
- Exceptional on-resistance and maximum DC current capability.





Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		NDS331N	Units	
V _{DSS}	Drain-Source Voltage		20	V	
V _{gss}	Gate-Source Voltage - Continuous		8	V	
I _D	Maximum Drain Current - Continuous	(Note 1a)	1.3	А	
	- Pulsed		10		
P _D	Maximum Power Dissipation	(Note 1a)	0.5	W	
		(Note 1b)	0.46		
T_,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C	
THERMA	L CHARACTERISTICS				
R _{θJA}	Thermal Resistance, Junction-to-Ambient		250	°C/W	
R _{θJC}	Thermal Resistance, Junction-to-Case	(Note 1)	75	°C/W	

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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		20			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$				1	μA
			T _J =125°C			10	μA
I _{GSSF}	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
$V_{GS(th)}$	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA		0.5	0.7	1	V
			T _J =125°C	0.3	0.53	0.8	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = 2.7 V, I _D = 1.3 A			0.15	0.21	Ω
			T _J =125°C		0.24	0.4	
		V _{GS} = 4.5 V, I _D = 1.5 A			0.11	0.16	
I _{D(ON)}	On-State Drain Current	V _{GS} = 2.7 V, V _{DS} = 5 V		3			А
		$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$		4			
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 1.3 A,			3.5		S
DYNAMIC	CHARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1.0 MHz			162		pF
C _{oss}	Output Capacitance				85		pF
C _{rss}	Reverse Transfer Capacitance				28		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 5 \text{ V}, \text{ R}_{Gen} = 6 \Omega$			5	20	ns
t,	Turn - On Rise Time				25	40	ns
t _{D(off)}	Turn - Off Delay Time				10	20	ns
t _r	Turn - Off Fall Time				5	20	ns
Q _g	Total Gate Charge	$V_{DS} = 5 V, I_D = 1.3 A,$ $V_{GS} = 4.5 V$			3.5	5	nC
Q _{gs}	Gate-Source Charge				0.3		nC
Q _{gd}	Gate-Drain Charge				1		nC

Electrical Characteristics (T _A = 25°C unless otherwise noted)							
Symbol	Parameter	eter Conditions		Тур	Max	Units	
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
I _s	Maximum Continuous Drain-Source Diode Forward Current				0.42	А	
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				10	Α	
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 0.42 A (Note 2)$		0.8	1.2	V	
Notes:		-					

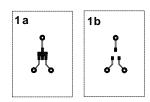
1. R_{gub} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{gub} is guaranteed by design while R_{gub} is determined by the user's board design.

 $P_D(t) = \frac{T_J - T_A}{R_{\Theta J} \downarrow t} = \frac{T_J - T_A}{R_{\Theta J} \downarrow t^R_{\Theta C} \downarrow t} = I_D^2(t) \times R_{DS(OV)}$

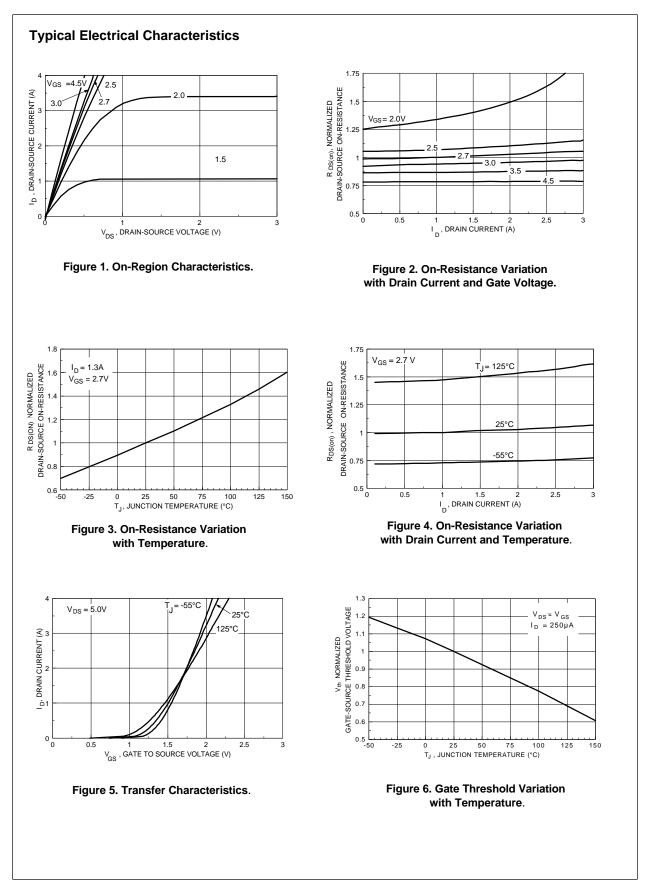
Typical $\rm R_{_{B^{J\!A}}}$ using the board layouts shown below on 4.5"x5" FR-4 PCB in a still air environment:

a. 250°C/W when mounted on a 0.02 \mbox{in}^2 pad of 2oz copper.

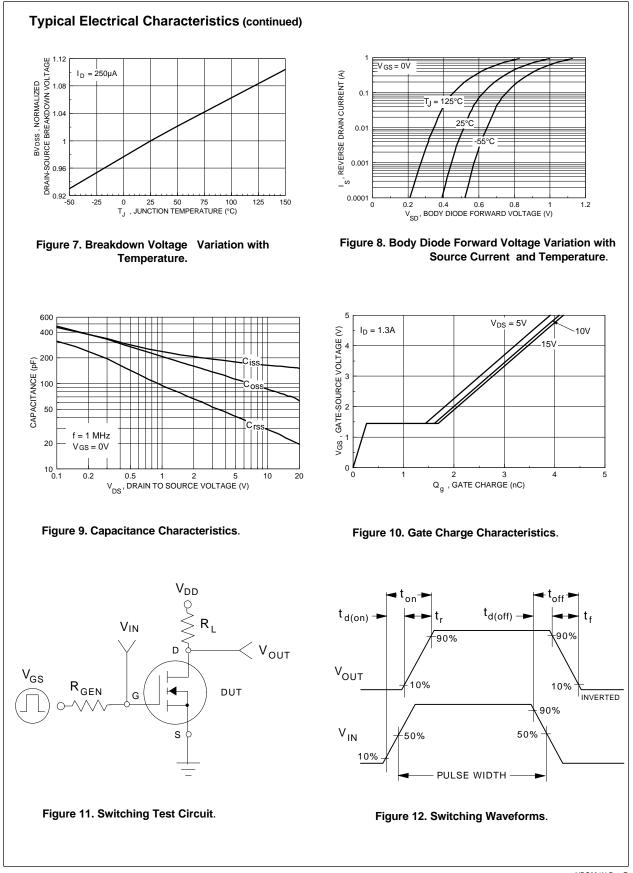
b. 270°C/W when mounted on a 0.001 \mbox{in}^2 pad of 2oz copper.



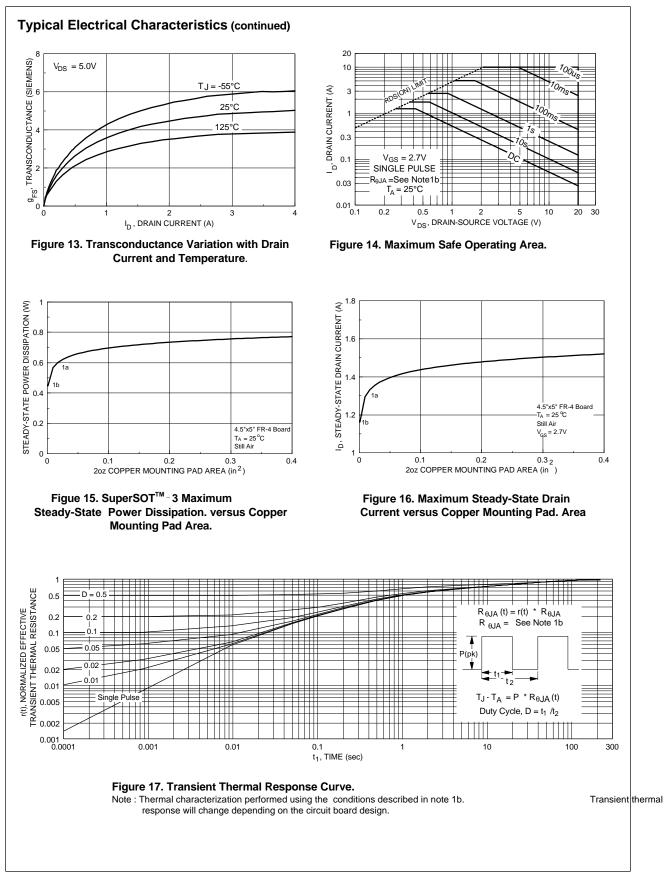
 $\label{eq:Scale 1: 1 on letter size paper} Scale 1: 1 on letter size paper \\ 2. Pulse Test: Pulse Width \le 300 \mu s, Duty Cycle \le 2.0\%.$



NDS331N Rev.E



NDS331N Rev.E



NDS331N Rev.E

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